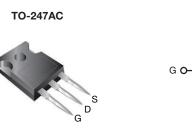
## SiHG47N60EF

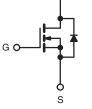


**Vishay Siliconix** 

# **E Series Power MOSFET with Fast Body Diode**

PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.065		
Q <sub>g</sub> max. (nC)	228			
Q <sub>gs</sub> (nC)	32			
Q <sub>gd</sub> (nC)	62			
Configuration	Single			





N-Channel MOSFET

### **FEATURES**

- Fast body diode MOSFET using E series technology
- Reduced t<sub>rr</sub>, Q<sub>rr</sub>, and I<sub>RRM</sub>
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C<sub>iss</sub>)
- Increased robustness due to low Q<sub>rr</sub>
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Telecommunications
  - Server and telecom power supplies
- Lighting
  - High-intensity lighting (HID)
- Light emitting diodes (LEDs)
- Consumer and computing
  ATX power supplies
- Industrial
- Welding
- Battery chargers
- Renewable energy
- Solar (PV inverters)
- Switching mode power supplies (SMPS)
- Applications using the following topologies
- LLC
- Phase shifted bridge (ZVS)
- 3-level inverter
- AC/DC bridge

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free and Halogen-free	SiHG47N60EF-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \text{ °C}$ , unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V <sub>DS</sub>	600	V		
Gate-Source Voltage			V <sub>GS</sub>	± 30	v		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C T <sub>C</sub> = 100 °C	- I <sub>D</sub>	47			
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		29	А		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	138			
Linear Derating Factor				3	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	1500	mJ		
Maximum Power Dissipation			PD	379	W		
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C		d\//dt	70	V/ns		
Reverse Diode dV/dt <sup>d</sup>		dV/dt	11	v/ns			
Soldering Recommendations (Peak Temperature) <sup>c</sup>	for 10 s			300	°C		

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 73.5 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 6.4 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D, \, dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		40				
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	- 0.33			°C/W		
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	-		ONS	MIN.	TYP.	MAX.	
Static	OTHEOL	120	TOONDIIN			<u> </u>	101.47.	UN
Drain-Source Breakdown Voltage	V <sub>DS</sub>	Vee	= 0 V, I <sub>D</sub> = 2	50 uA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>		e to 25 °C, I		-		_	V/°C
					2.0		4.0	V/ C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>		$= V_{GS}, I_D = 2$		2.0	-	4.0	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{GS} = \pm 20 V$			-	-	± 100	nA
			$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V		-	-	1	μA	
	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{\text{J}} = 125 \text{ °C}$		T <sub>J</sub> = 125 °C	-	-	500		
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	5	= 24 A	-	0.056	0.065	Ω
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub>	$= 30 \text{ V}, \text{ I}_{\text{D}} =$	24 A	-	17	-	S
Dynamic								
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	5000	-	pF	
Output Capacitance	Coss			-	220	-		
Reverse Transfer Capacitance	C <sub>rss</sub>			-	7	-		
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	172	-		
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	634	-		
Total Gate Charge	Qg	V <sub>GS</sub> = 10 V I <sub>D</sub> = 24 A, V <sub>DS</sub> = 480 V		-	152	228	nC	
Gate-Source Charge	Q <sub>gs</sub>			-	32	-		
Gate-Drain Charge	Q <sub>gd</sub>				-	62	-	1
Turn-On Delay Time	t <sub>d(on)</sub>				-	30	60	
Rise Time	t <sub>r</sub>	Voo -	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 24 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.4 \Omega$		-	56	84	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	00			-	91	137	
Fall Time	t <sub>f</sub>			-	56	84		
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	0.46	-	Ω	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	47		
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	138	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 24 A, V <sub>GS</sub> = 0 V		-	0.9	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 24 \text{ A},$ dl/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	199	398	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			_	1.4	2.8	μΟ	
Body blode neverse necevery charge	۲r				13.2	2.0	A	

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

2



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

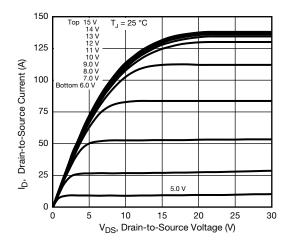


Fig. 1 - Typical Output Characteristics

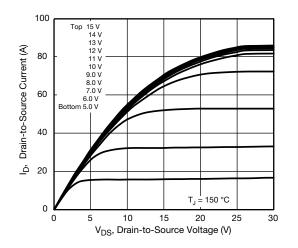
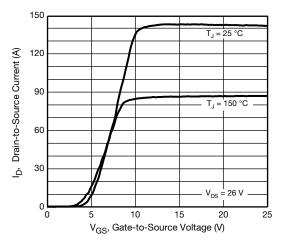


Fig. 2 - Typical Output Characteristics





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3.0 I٦ = 24 A R<sub>DS(on)</sub>, Drain-to-Source On Resistance (Normalized) 2.5 2.0 1.5 1.0 0.5 ۷<sub>GS</sub> = 10 V 0.0 140 160 - 60 - 40 - 20 0 20 40 60 80 100 120 T<sub>J</sub>, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

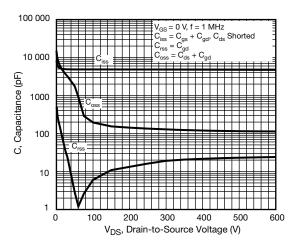
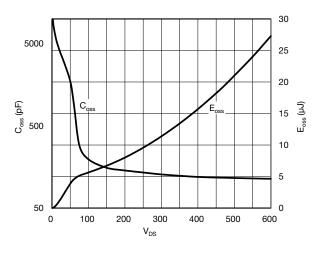
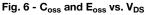


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





**3** For technical questions, contact: <u>hvm@vishay.com</u>

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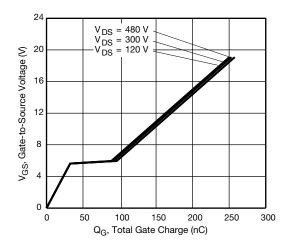


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

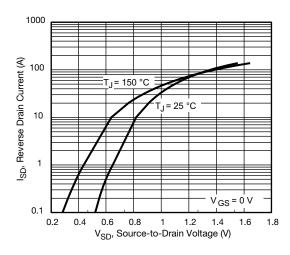


Fig. 8 - Typical Source-Drain Diode Forward Voltage

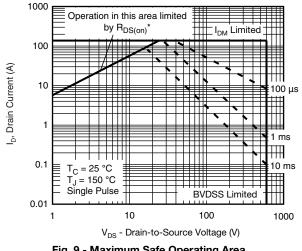


Fig. 9 - Maximum Safe Operating Area

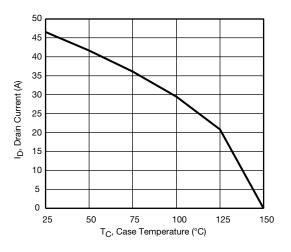


Fig. 10 - Maximum Drain Current vs. Case Temperature

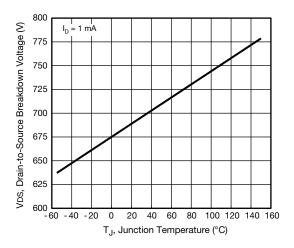
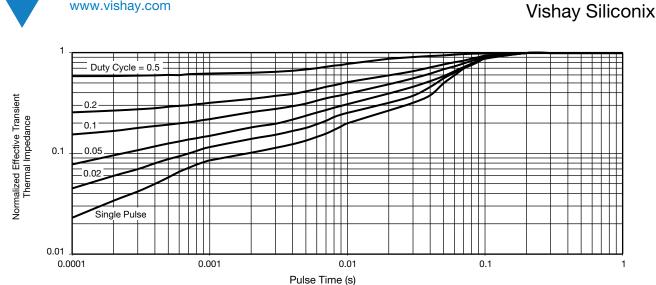
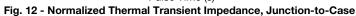


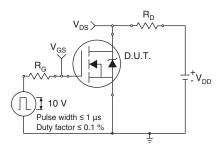
Fig. 11 - Temperature vs. Drain-to-Source Voltage

4

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Fig. 13 - Switching Time Test Circuit

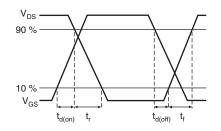


Fig. 14 - Switching Time Waveforms

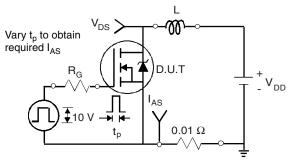


Fig. 15 - Unclamped Inductive Test Circuit

V<sub>DS</sub>  $V_{DD}$ V<sub>DS</sub> I<sub>AS</sub>

SiHG47N60EF

Fig. 16 - Unclamped Inductive Waveforms

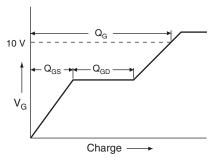


Fig. 17 - Basic Gate Charge Waveform

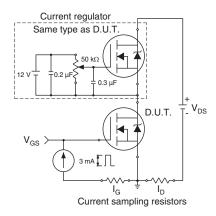


Fig. 18 - Gate Charge Test Circuit

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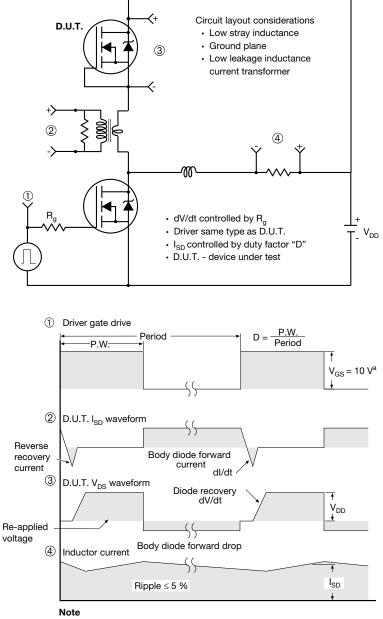
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### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 19 - For N-Channel

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